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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic18f24q10-i-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic18f24q10-i-ss</a>

- Reliable data/program memory monitoring for Fail-Safe operation (e.g., Class B)
- Calculate CRC over any portion of Flash or EEPROM
- High-speed or background operation
- Hardware Limit Timer (TMR2/4/6+HLT):
  - Hardware monitoring and Fault detection
- Peripheral Pin Select (PPS):
  - Enables pin mapping of digital I/O
- Data Signal Modulator (DSM)

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## Analog Peripherals

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- 10-Bit Analog-to-Digital Converter with Computation (ADC<sup>2</sup>):
  - 24 external channels
  - Conversion available during sleep
  - Four internal analog channels
  - Internal and external trigger options
  - Automated math functions on input signals:
    - Averaging, filter calculations, oversampling and threshold comparison
  - 8-bit hardware acquisition timer
- Hardware Capacitive Voltage Divider (CVD) Support:
  - 8-bit precharge timer
  - Adjustable sample and hold capacitor array
  - Guard ring digital output drive
- Zero-Cross Detect (ZCD):
  - Detect when AC signal on pin crosses ground
- 5-Bit Digital-to-Analog Converter (DAC):
  - Output available externally
  - Programmable 5-bit voltage (% of  $V_{DD}$ ,  $[V_{Ref+} - V_{Ref-}]$ , FVR)
  - Internal connections to comparators and ADC
- Two Comparators (CMP):
  - Four external inputs
  - External output via PPS
- Fixed Voltage Reference (FVR) Module:
  - 1.024V, 2.048V and 4.096V output levels
  - Two buffered outputs: One for DAC/CMP and one for ADC

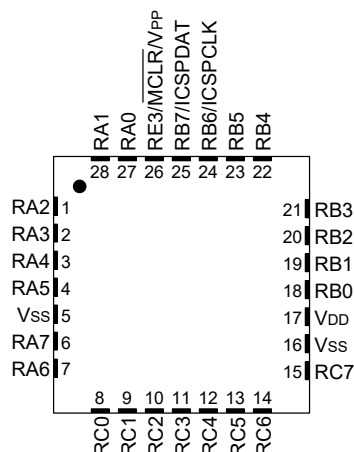
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## Clocking Structure

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- High-Precision Internal Oscillator Block (HFINTOSC):
  - Selectable frequencies up to 64 MHz
  - $\pm 1\%$  at calibration
- 32 kHz Low-Power Internal Oscillator (LFINTOSC)
- External 32 kHz Crystal Oscillator (SOSC)
- External High-frequency Oscillator Block:
  - Three crystal/resonator modes

Figure 2. 28-pin QFN, VQFN



Rev. 00-000028B  
6/23/2017

**Note:** It is recommended that the exposed bottom pad be connected to  $V_{SS}$ , however it must not be the only  $V_{SS}$  connection to the device.

### Pin Allocation Tables

Table 1. 28-Pin Allocation Table

I/O(2)	28-Pin SPDIP, SOIC, SSOP	28-Pin (V)QFN	A/D	Reference	Comparator	Timers	CCP	CWG	ZCD	Interrupt	EUSART	DSM	MSSP	Pull-up	Basic
RA0	2	27	ANA0	—	C1IN0- C2IN0-	—	—	—	—	IOCA0	—	—	—	Y	—
RA1	3	28	ANA1	—	C1IN1- C2IN1-	—	—	—	—	IOCA1	—	—	—	Y	—
RA2	4	1	ANA2	DAC1OUT1 Vref- (DAC) Vref- (ADC)	C1IN0+ C2IN0+	—	—	—	—	IOCA2	—	—	—	Y	—
RA3	5	2	ANA3	Vref+ (DAC) Vref+ (ADC)	C1IN1+	—	—	—	—	IOCA3	—	MDCARL <sup>(1)</sup>	—	Y	—
RA4	6	3	ANA4	—	—	T0CKI <sup>(1)</sup>	—	—	—	IOCA4	—	MDCARH <sup>(1)</sup>	—	Y	—
RA5	7	4	ANA5	—	—	—	—	—	—	IOCA5	—	MDSRC <sup>(1)</sup>	SS1 <sup>(1)</sup>	Y	—
RA6	10	7	ANA6	—	—	—	—	—	—	IOCA6	—	—	—	Y	CLKOUT OSC2
RA7	9	6	ANA7	—	—	—	—	—	—	IOCA7	—	—	—	Y	OSC1 CLKIN
RB0	21	18	ANB0	—	C2IN1+	—	—	CWG1 <sup>(1)</sup>	ZCDIN	IOCB0 INT0 <sup>(1)</sup>	—	—	—	Y	—
RB1	22	19	ANB1	—	C1IN3- C2IN3-	—	—	—	—	IOCB1 INT1 <sup>(1)</sup>	—	—	—	Y	—
RB2	23	20	ANB2	—	—	—	—	—	—	IOCB2 INT2 <sup>(1)</sup>	—	—	—	Y	—

Value	Description
11	WDT enabled regardless of Sleep; SEN bit in WDTCON0 is ignored
10	WDT enabled while Sleep = 0, suspended when Sleep = 1; SEN bit in WDTCON0 is ignored
01	WDT enabled/disabled by SEN bit in WDTCON0
00	WDT disabled, SEN bit in WDTCON0 is ignored

**Bits 4:0 – WDTCP5[4:0]** WDT Period Select bits

WDTCP5	WDTCON0[WDTPS] at POR			Typical Time Out (F <sub>IN</sub> = 31 kHz)	Software Control of WDTPS?
	Value	Divider Ratio			
11111	01011	1:65536	2 <sup>16</sup>	2s	Yes
11110 ... 10011	11110 ... 10011	1:32	2 <sup>5</sup>	1 ms	No
10010	10010	1:8388608	2 <sup>23</sup>	256s	No
10001	10001	1:4194304	2 <sup>22</sup>	128s	
10000	10000	1:2097152	2 <sup>21</sup>	64s	
01111	01111	1:1048576	2 <sup>20</sup>	32s	
01110	01110	1:524299	2 <sup>19</sup>	16s	
01101	01101	1:262144	2 <sup>18</sup>	8s	
01100	01100	1:131072	2 <sup>17</sup>	4s	
01011	01011	1:65536	2 <sup>16</sup>	2s	
01010	01010	1:32768	2 <sup>15</sup>	1s	
01001	01001	1:16384	2 <sup>14</sup>	512 ms	
01000	01000	1:8192	2 <sup>13</sup>	256 ms	
00111	00111	1:4096	2 <sup>12</sup>	128 ms	
00110	00110	1:2048	2 <sup>11</sup>	64 ms	
00101	00101	1:1024	2 <sup>10</sup>	32 ms	
00100	00100	1:512	2 <sup>9</sup>	16 ms	
00011	00011	1:256	2 <sup>8</sup>	8 ms	
00010	00010	1:128	2 <sup>7</sup>	4 ms	
00001	00001	1:64	2 <sup>6</sup>	2 ms	
00000	00000	1:32	2 <sup>5</sup>	1 ms	

10.8.5 STATUS

**Name:** STATUS  
**Address:** 0xFD8

Status Register

Bit	7	6	5	4	3	2	1	0
		$\overline{TO}$	$\overline{PD}$	N	OV	Z	DC	C
Access		R	R	R/W	R/W	R/W	R/W	R/W
Reset		1	1	0	0	0	0	0

**Bit 6 –  $\overline{TO}$**  Time-Out bit  
Reset States: POR/BOR = 1  
All Other Resets = q

Value	Description
1	Set at power-up or by execution of CLRWDT or SLEEP instruction
0	A WDT time-out occurred

**Bit 5 –  $\overline{PD}$**  Power-Down bit  
Reset States: POR/BOR = 1  
All Other Resets = q

Value	Description
1	Set at power-up or by execution of CLRWDT instruction
0	Cleared by execution of the SLEEP instruction

**Bit 4 – N** Negative bit  
Used for signed arithmetic (2's complement); indicates if the result is negative, (ALU MSb = 1).  
Reset States: POR/BOR = 0  
All Other Resets = u

Value	Description
1	The result is negative
0	The result is positive

**Bit 3 – OV** Overflow bit  
Used for signed arithmetic (2's complement); indicates an overflow of the 7-bit magnitude, which causes the sign bit (bit 7) to change state.  
Reset States: POR/BOR = 0  
All Other Resets = u

Value	Description
1	Overflow occurred for current signed arithmetic operation
0	No overflow occurred

**Bit 2 – Z** Zero bit  
Reset States: POR/BOR = 0

**10.8.6 WREG**

**Name:** WREG  
**Address:** 0xFE8

Shadow of Working Data Register

Bit	7	6	5	4	3	2	1	0
	WREG[7:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	x	x	x	x	x	x	x	x

**Bits 7:0 – WREG[7:0]**

```
BSF    INTCON, GIE    ; re-enable interrupts
BCF    NVMCON0, NVMEN ; disable writes to memory
```



### Important:

1. If a write or erase operation is terminated by an unexpected event, NVMERR bit will be set which the user can check to decide whether a rewrite of the location(s) is needed.
2. NVMERR is set if SECER is written to '1' while NVMADR points to a write-protected address.
3. NVMERR is set if SECER is written to '1' while NVMADR points to an invalid address location ( Refer to the device memory map and NVM Organization Table).

### Related Links

[11. \(NVM\) Nonvolatile Memory Control](#)

#### 11.1.4 Writing to Program Flash Memory

Program memory can be written either one word at a time or a sector at a time.

A single word is written by setting the NVMADR to the target address and loading NVMDAT with the desired word. The word is then transferred to Flash memory with the [11.5.2.3 WR](#) unlock and write sequence.

A sector is written by first loading a block of holding registers and then executing a sector write sequence. The programming write block size is specified as the holding registers, also referred to as sector RAM, in the Flash Memory Organization by Device table. Table writes are used to write the holding register bytes that are then transferred to Flash memory with the [11.5.2.2 SECWR](#) unlock and write sequence. There are only as many holding registers as there are bytes in a write block.

Since the table latch ([11.5.6 TABLAT](#)) is only a single byte, the TBLWT instruction needs to be executed multiple times for each sector programming operation. The write protection state is ignored for table writes. All of the table write operations will essentially be short writes because only the holding registers are written. NVMIF is not affected while writing to the holding registers.

After all the holding registers have been written, the programming operation of that sector of memory is started by setting NVMADR to an address within the target sector and executing a sector write unlock sequence followed immediately by setting the [11.5.2.2 SECWR](#) bit.

If the PFM address in the NVMADR is write-protected, or if NVMADR points to an invalid location, the SECWR bit is cleared without any effect and the [11.5.1.2 NVMERR](#) is set.

CPU operation is suspended during a long write cycle and resumes when the operation is complete. The long write operation completes in one extended instruction cycle. When complete, the SECWR or WR bit is cleared by hardware and NVMIF is set. An interrupt will occur if NVMIE is also set. The holding registers are unchanged. NVMEN is not changed.

The internal programming timer controls the write time. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device.

**11.5.1 NVMCON0**

**Name:** NVMCON0  
**Address:** 0xF7F

Nonvolatile Memory Control 0 Register

Bit	7	6	5	4	3	2	1	0
	NVMEN			NVMERR	Reserved			
Access	R/W			R/W/HS	R/W			
Reset	0			x	0			

**Bit 7 – NVMEN** NVM Enable bit

Value	Description
1	NVM is enabled for all operations
0	NVM is disabled for all operations except single byte or word read.

**Bit 4 – NVMERR**

NVM Error Flag bit

Value	Description
1	An attempted NVM write or sector read did not complete successfully. Must be cleared by software.
0	All NVM operations have completed successfully.

**Bit 3 – Reserved**

Reserved - Do not use. This bit must be maintained as '0'.



**11.5.3 NVMCON2**

**Name:** NVMCON2  
**Address:** 0xF81

Nonvolatile Memory Control 2 Register

**Note:** This register always reads zeros, regardless of data written.  
Refer to the NVM Unlock Sequence section

Bit	7	6	5	4	3	2	1	0
	NVMCON2[7:0]							
Access	WO	WO	WO	WO	WO	WO	WO	WO
Reset	0	0	0	0	0	0	0	0

**Bits 7:0 – NVMCON2[7:0]**

## 12. 8x8 Hardware Multiplier

### 12.1 Introduction

All PIC18 devices include an 8x8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in [Table 12-1](#).

### 12.2 Operation

[Example 12-1](#) shows the instruction sequence for an 8x8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

[Example 12-2](#) shows the sequence to do an 8x8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

#### Example 12-1. 8x8 Unsigned Multiply Routine

```
MOVWF   ARG1, W   ;
MULWF   ARG2      ; ARG1 * ARG2 -> PRODH:PRODL
```

#### Example 12-2. 8x8 Signed Multiply Routine

```
MOVWF   ARG1, W
MULWF   ARG2      ; ARG1 * ARG2 -> PRODH:PRODL
BTFSC   ARG2, SB  ; Test Sign Bit
SUBWF   PRODH, F  ; PRODH = PRODH - ARG1
MOVWF   ARG2, W
BTFSC   ARG1, SB  ; Test Sign Bit
SUBWF   PRODH, F  ; PRODH = PRODH - ARG2
```

**Table 12-1. Performance Comparison for Various Multiply Operations**

Routine	Multiply Method	Program Memory (Words)	Cycles (Max)	Time			
				@ 64 MHz	@ 40 MHz	@ 10 MHz	@ 4 MHz
8x8 unsigned	Without hardware multiply	13	69	4.3 µs	6.9 µs	27.6 µs	69 µs
	Hardware multiply	1	1	62.5 ns	100 ns	400 ns	1 µs

14.13.22 IPR4

**Name:** IPR4  
**Address:** 0xEB9

Peripheral Interrupt Priority Register 4

Bit	7	6	5	4	3	2	1	0
			TMR6IP	TMR5IP	TMR4IP	TMR3IP	TMR2IP	TMR1IP
Access			R/W	R/W	R/W	R/W	R/W	R/W
Reset			1	1	1	1	1	1

**Bit 5 – TMR6IP** TMR6 to PR6 Match Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

**Bit 4 – TMR5IP** TMR5 Overflow Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

**Bit 3 – TMR4IP** TMR4 to PR4 Match Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

**Bit 2 – TMR3IP** TMR3 Overflow Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

**Bit 1 – TMR2IP** TMR2 to PR2 Match Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

**Bit 0 – TMR1IP** TMR1 Overflow Interrupt Priority bit

Value	Description
1	High priority
0	Low priority

15.5.8 LATA

**Name:** LATA  
**Address:** 0xF82

Output Latch Register

Bit	7	6	5	4	3	2	1	0
	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	x	x	x	x	x	x	x	x

**Bits 0, 1, 2, 3, 4, 5, 6, 7 – LATAn** Output Latch A Value bits

Reset States: POR/BOR = xxxxxxxx

All Other Resets = uuuuuuuu

**Note:** Writes to LATA are equivalent with writes to the corresponding PORTA register. Reads from LATA register return register values, not I/O pin values.

### 17.9.1 Peripheral xxx Input Selection

**Name:** xxxPPS



**Important:** The Reset value of this register is determined by the device default for each peripheral.  
Refer to the [input selection table](#) for a list of available ports and default pin locations.

	7	6	5	4	3	2	1	0
				PORT[1:0]		PIN[2:0]		
Access				R/W	R/W	R/W	R/W	R/W
Reset				g	g	g	g	g

**Bits 4:3 – PORT[1:0]** Peripheral xxx Input PORT Selection bits

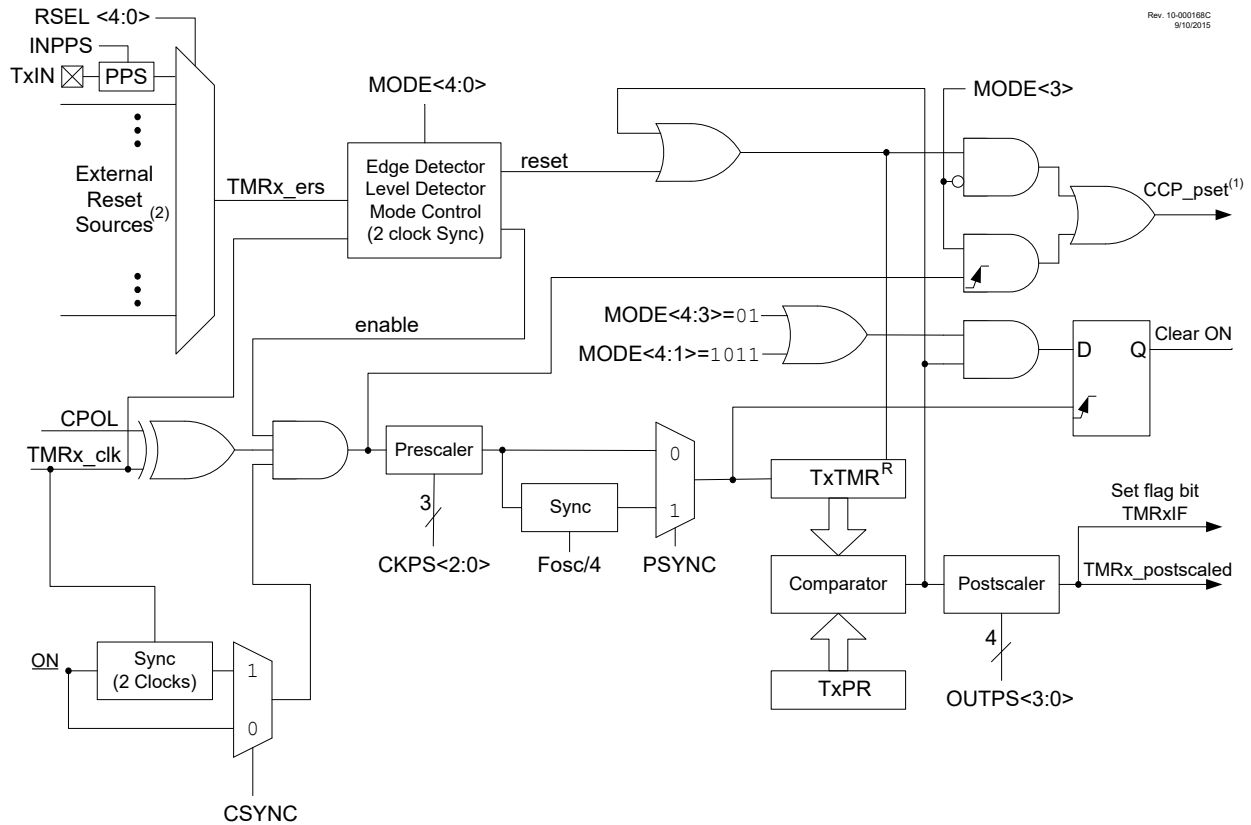
See the [input selection table](#) for a list of available ports and default pin locations.

Value	Description
10	PORTC
01	PORTB
00	PORTA

**Bits 2:0 – PIN[2:0]** Peripheral xxx Input Pin Selection bits

Value	Description
111	Peripheral input is from PORTx Pin 7 (Rx7)
110	Peripheral input is from PORTx Pin 6 (Rx6)
101	Peripheral input is from PORTx Pin 5 (Rx5)
100	Peripheral input is from PORTx Pin 4 (Rx4)
011	Peripheral input is from PORTx Pin 3 (Rx3)
010	Peripheral input is from PORTx Pin 2 (Rx2)
001	Peripheral input is from PORTx Pin 1 (Rx1)
000	Peripheral input is from PORTx Pin 0 (Rx0)

Figure 20-1. Timer2 with Hardware Limit Timer (HLT) Block Diagram



**Note:**

1. Signal to the CCP to trigger the PWM pulse.
2. See TxRST for external Reset sources.

Table 20-1. Clock Source Selection

CS<3:0>	Clock Source		
	Timer2	Timer4	Timer6
1111-1001	Reserved	Reserved	Reserved
1000	ZCD_OUT	ZCD_OUT	ZCD_OUT
0111	CLKREF_OUT	CLKREF_OUT	CLKREF_OUT
0110	SOSC	SOSC	SOSC
0101	MFINTOSC (31 kHz)	MFINTOSC (31 kHz)	MFINTOSC (31 kHz)
0100	LFINTOSC	LFINTOSC	LFINTOSC
0011	HFINTOSC	HFINTOSC	HFINTOSC
0010	Fosc	Fosc	Fosc

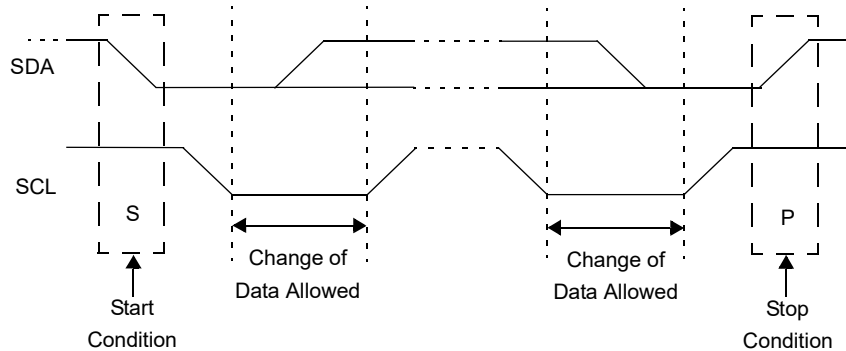
26.4.8 Stop Condition

A Stop condition is a transition of the SDA line from low-to-high state while the SCL line is high.



**Important:** At least one SCL low time must appear before a Stop is valid, therefore, if the SDA line goes low then high again while the SCL line stays high, only the Start condition is detected.

Figure 26-12. I<sup>2</sup>C Start and Stop Conditions



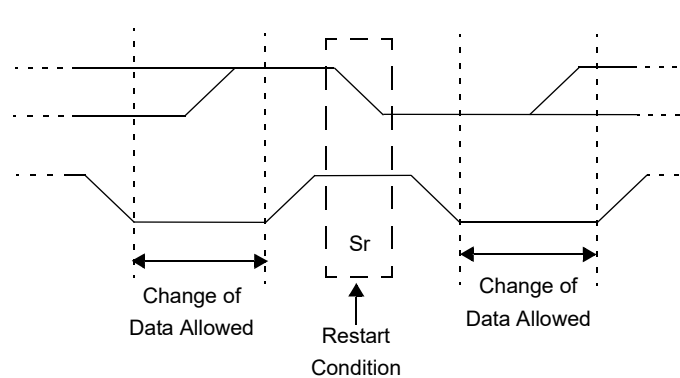
26.4.9 Restart Condition

A Restart is valid any time that a Stop would be valid. A master can issue a Restart if it wishes to hold the bus after terminating the current transfer. A Restart has the same effect on the slave that a Start would, resetting all slave logic and preparing it to clock in an address. The master may want to address the same or another slave. Figure 26-13 shows the wave form for a Restart condition.

In 10-bit Addressing Slave mode a Restart is required for the master to clock data out of the addressed slave. Once a slave has been fully addressed, matching both high and low address bytes, the master can issue a Restart and the high address byte with the R/W bit set. The slave logic will then hold the clock and prepare to clock out data.

After a full match with R/W clear in 10-bit mode, a prior match flag is set and maintained until a Stop condition, a high address with R/W clear, or high address match fails.

Figure 26-13. I<sup>2</sup>C Restart Condition





**Important:**

1. If the master  $\overline{ACK}$ s then the clock will be stretched.
  2. ACKSTAT is the only bit updated on the rising edge of the ninth SCL clock instead of the falling edge.
- 
13. Steps 9-13 are repeated for each transmitted byte.
  14. If the master sends a not  $\overline{ACK}$ ; the clock is not held, but SSPxIF is still set.
  15. The master sends a Restart condition or a Stop.
  16. The slave is no longer addressed.



**Note:** If the RX/DT function is on an analog pin, the corresponding ANSEL bit must be cleared for the receiver to function.

#### 27.3.1.6 Receive Overrun Error

The receive FIFO buffer can hold two characters. An overrun error will be generated if a third character, in its entirety, is received before RCxREG is read to access the FIFO. When this happens the OERR bit of the RCxSTA register is set. Previous data in the FIFO will not be overwritten. The two characters in the FIFO buffer can be read, however, no additional characters will be received until the error is cleared. The OERR bit can only be cleared by clearing the overrun condition. If the overrun error occurred when the SREN bit is set and CREN is clear then the error is cleared by reading RCxREG. If the overrun occurred when the CREN bit is set then the error condition is cleared by either clearing the CREN bit of the RCxSTA register or by clearing the SPEN bit which resets the EUSART.

#### 27.3.1.7 Receiving 9-Bit Characters

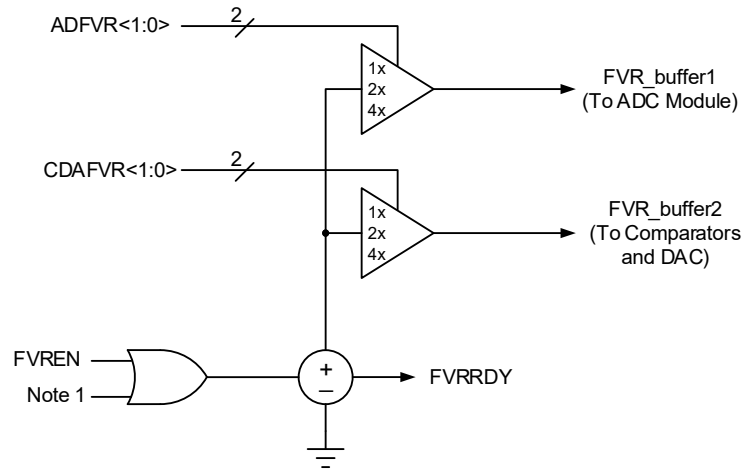
The EUSART supports 9-bit character reception. When the RX9 bit of the RCxSTA register is set the EUSART will shift nine bits into the RSR for each character received. The RX9D bit of the RCxSTA register is the ninth, and Most Significant, data bit of the top unread character in the receive FIFO. When reading 9-bit data from the receive FIFO buffer, the RX9D data bit must be read before reading the eight Least Significant bits from the RCxREG.

#### 27.3.1.8 Synchronous Master Reception Setup

1. Initialize the SPxBRGH:SPxBRGL register pair and set or clear the BRG16 bit, as required, to achieve the desired baud rate.
2. Select the receive input pin by writing the appropriate values to the RxyPPS register and RXxPPS register. Both selections should enable the same pin.
3. Select the clock output pin by writing the appropriate values to the RxyPPS register and CKxPPS register. Both selections should enable the same pin.
4. Clear the ANSEL bit for the RXx pin (if applicable).
5. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
6. Ensure bits CREN and SREN are clear.
7. If interrupts are desired, set the RCxIE bit of the PIEx register and the GIE and PEIE bits of the INTCON register.
8. If 9-bit reception is desired, set bit RX9.
9. Start reception by setting the SREN bit or for continuous reception, set the CREN bit.
10. Interrupt flag bit RCxIF will be set when reception of a character is complete. An interrupt will be generated if the enable bit RCxIE was set.
11. Read the RCxSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
12. Read the 8-bit received data by reading the RCxREG register.
13. If an overrun error occurs, clear the error by either clearing the CREN bit of the RCxSTA register or by clearing the SPEN bit which resets the EUSART.

Figure 28-1. Voltage Reference Block Diagram

Rev. 10-000-053C  
12/02/13



### 28.3 Register Summary - FVR

Address	Name	Bit Pos.							
0x0F2C	FVRCON	7:0	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR[1:0]		ADFVR[1:0]

### 28.4 Register Definitions: FVR Control

# PIC18F24/25Q10

## Instruction Set Summary

If ZERO = 1;  
PC = address (HERE + 2)

BRA	Unconditional Branch			
Syntax:	BRA n			
Operands:	$-1024 \leq n \leq 1023$			
Operation:	$(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1101	0nnn	nnnn	nnnn
Description:	Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be $PC + 2 + 2n$ . This instruction is a 2-cycle instruction.			
Words:	1			
Cycles:	2			

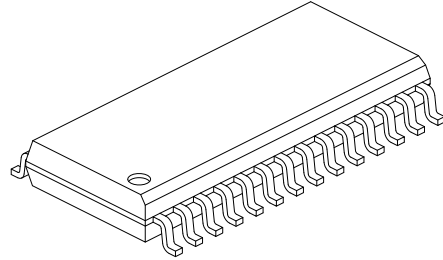
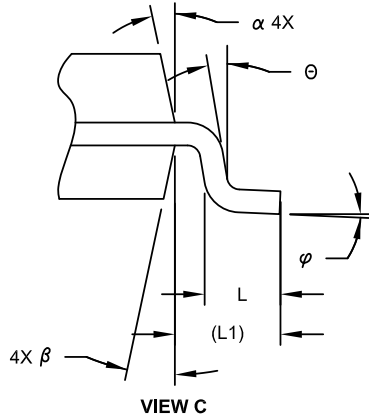
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example:	HERE	BRA	Jump
Before Instruction PC = address (HERE)			
After Instruction PC = address (Jump)			

BSF	Bit Set f			
Syntax:	BSF f, b {,a}			
Operands:	$0 \leq f \leq 255$ $0 \leq b \leq 7$ $a \in [0,1]$			
Operation:	$1 \rightarrow f<b>$			
Status Affected:	None			
Encoding:	1000	bbba	fff	fff

**28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		MILLIMETERS		
Units				
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	1.27 BSC		
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	17.90 BSC		
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1	1.40 REF		
Lead Angle	θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M  
 BSC: Basic Dimension, Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

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